



ENG-E23-033 - Distributors

JAE Electronics, Inc.
March 31st, 2023

PCN (Process Change Notice) MX34014SFA Replacement Mold Die (1A,1B,1C,1D) To Keep Production Capacity

Part Number	6 Existing Mold Dies	1 Replacement Mold Die created with 4 cavities	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34014SFA	(G,H), (J,K), (L,M), (N,P) (Q,R), (T,U,V,W) ** Pending PCN, ENG-E22-112_Replacement Mold Die (W,X,Y,Z) to replace (L,M) (N,P), released on 11/27/22	(1A,1B,1C,1D) To replace (J,K)	August 2023	October 2023	January 2024

Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process
 1. PC PPAP will only be prepared and provided to customer who already requested and received initial PPAP.
 2. If you request PC PPAP documents for this notification, please notify us ASAP.